TOSHIBA Photocoupler Photorelay

# TLP197GA

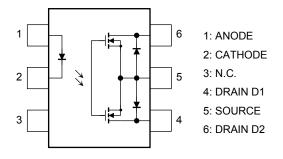
PBX Telecommunication Modem · FAX Cards, Modems In PC Measurement Instrumentation

The TOSHIBA TLP197GA consists of an infrared emitting diode optically coupled to a photo-MOSFET in a SOP, which is suitable for surface mount assembly.

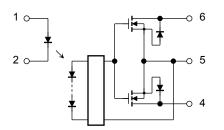
The TLP197GA is suitable for replacement of mechanical relays in many applications which require space savings.

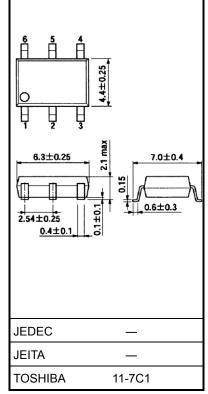
- 6 pin SOP (2.54SOP6): 2.1 mm high, 2.54 mm pitch
- 1-form-A
- Peak off-state voltage: 400 V (min)
- Trigger LED current: 3 mA (max)
- On-state current: 120 mA (max)
- On-state resistance:  $35 \Omega$  (max)
- Isolation voltage: 1500 Vrms (min)
- UL-recognized: UL 1577, File No.E67349

#### Pin Configuration (top view)



#### Schematic





Weight: 0.13 g (typ.)

Unit: mm

#### Absolute Maximum Ratings (Ta = 25°C)

Characteristics			Symbol	Rating	Unit				
	Forward current		١ <sub>F</sub>	50	mA				
	Forward current derating (Ta ≥ 25°C)		∆IF/°C	-0.5	mA/°C				
	Peak forward current (100 μs pulse, 100 pps)		IFP	1	А				
LED	Reverse voltage		VR	5	V				
	Diode power dissi	pation	PD	50	mW				
	Diode power dissipation derating (Ta $\ge$ 25°C)		∆P <sub>D</sub> /°C	-0.5	mW/°C				
	Junction temperat	ure	Tj	125	°C				
	Off-state output te	erminal voltage	VOFF	400	V				
	On-state current	A connection		120					
		B connection	I <sub>ON</sub>	120	mA				
		C connection		240					
	On-state current derating (Ta ≥ 25°C)	A connection		-1.2					
		B connection	∆l <sub>ON</sub> /°C	-1.2	mA/°C				
ctor		C connection		-2.4					
Detector	Output power dissipation	A connection		432					
		B connection	Po	345	mW				
		C connection		690					
	Output power	A connection		-4.32					
	dissipation derating	B connection	ΔP <sub>O</sub> /°C	-3.45	mW /°C				
	(Ta ≥ 25°C)	C connection		-6.9					
	Junction temperat	ure	Tj	125	°C				
Operating temperature range			Topr	-40 to 85	°C				
Storage temperature range			T <sub>stg</sub>	-55 to 125	°C				
Lead	d soldering tempera	ture (10 s)	T <sub>sol</sub>	260	°C				
	ation voltage 60 s, R.H. ≤ 60 %)	(Note 1)	BVS	1500	Vrms				

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Device considered a two-terminal device: LED side pins shorted together, and DETECTOR side pins shorted together.

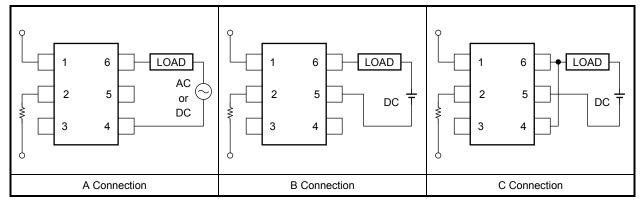
#### **Recommended Operating Conditions**

Characteristics	Symbol	Min	Тур.	Max	Unit
Supply voltage	Vdd	_	_	320	V
Forward current	lF	5	7.5	25	mA
On-state current	ION	_	—	120	mA
Operating temperature	Topr	-20	Ι	65	°C

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

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#### **Circuit Connections**



#### Individual Electrical Characteristics (Ta = 25°C)

	Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
LED	Forward voltage	VF	I <sub>F</sub> = 10 mA	1.0	1.15	1.3	V
	Reverse current	I <sub>R</sub>	$V_R = 5 V$	_	_	10	μA
	Capacitance	Ст	VF = 0 V, f = 1 MHz		30		pF
Detector	Off-state current	IOFF	V <sub>OFF</sub> = 400 V	_	_	1	μA
	Capacitance	COFF	V = 0 V, f = 1 MHz		70		pF

#### **Coupled Electrical Characteristics (Ta = 25°C)**

Characteristics		Symbol	Test Condition	Min	Тур.	Max	Unit
Trigger LED current		IFT	I <sub>ON</sub> = 120 mA	_	1	3	mA
Return LED current		IFC	IOFF = 100 μA	0.1	_	_	mA
	A connection	Ron	I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA	_	17	35	
On-state resistance	B connection		I <sub>ON</sub> = 120 mA, I <sub>F</sub> = 5 mA		11	20	Ω
	C connection		I <sub>ON</sub> = 240 mA, I <sub>F</sub> = 5 mA	_	6	_	

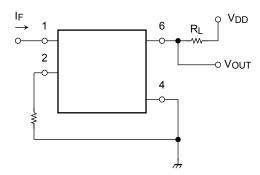
#### Isolation Characteristics (Ta = 25°C)

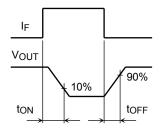
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Capacitance input to output	CS	$V_{S} = 0 V, f = 1 MHz$	_	0.8	_	pF
Isolation resistance	Rs	V <sub>S</sub> = 500 V, R.H. ≤ 60 %	5 × 10 <sup>10</sup>	10 <sup>14</sup>	_	Ω
Isolation voltage	BVS	AC, 60 s	1500			Vrms

#### Switching Characteristics (Ta = 25°C)

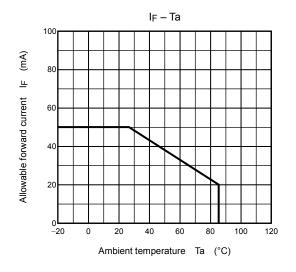
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Turn-on time	ton	$R_L = 200 \Omega$ (Note 2)	_	0.3	1	ms
Turn-off time	tOFF	$V_{DD} = 20 V$ , IF = 5 mA	_	0.1	1	ms

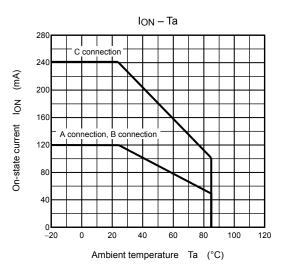
Note 2: Switching time test circuit

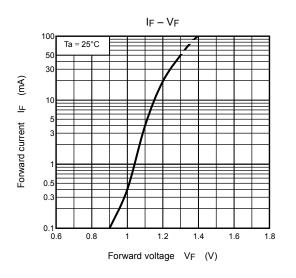


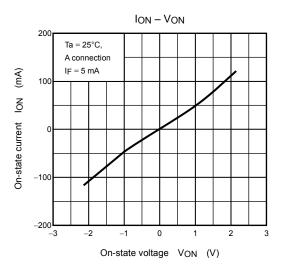


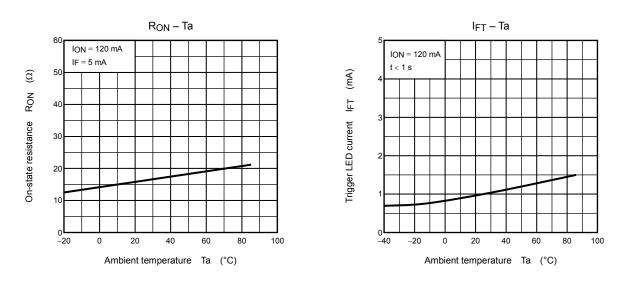
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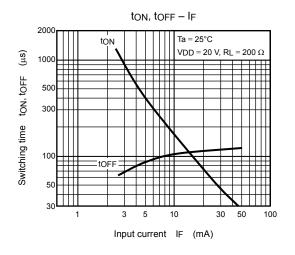


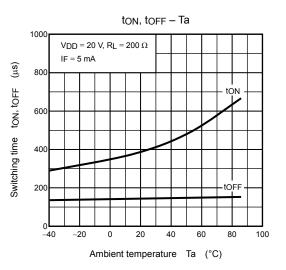


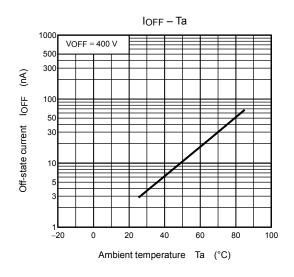


NOTE: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

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